

To our customers,

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## Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: <http://www.renesas.com>

April 1<sup>st</sup>, 2010  
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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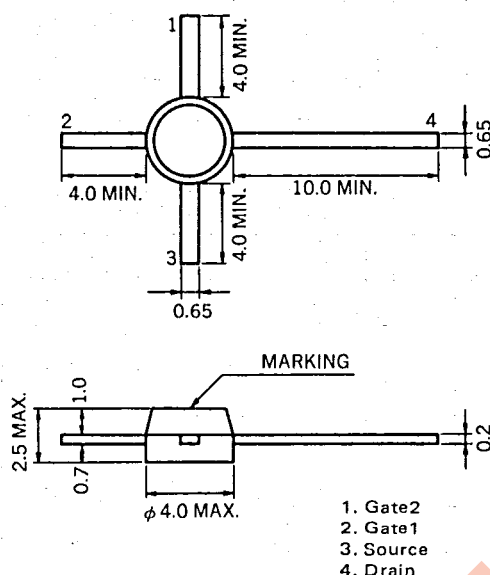
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## RF AMP. FOR UHF TV TUNER

## N-CHANNEL GaAs DUAL GATE MES FIELD-EFFECT TRANSISTOR

## 4PIN MINI MOLD

PACKAGE DIMENSIONS  
in millimeters

## FEATURES

- Suitable for use as RF amplifier in UHF TV tuner.
- Low  $C_{rss}$  : 0.02 pF TYP.
- High  $G_{PS}$  : 20 dB TYP.
- Low NF : 1.1 dB TYP.

ABSOLUTE MAXIMUM RATINGS ( $T_a = 25^\circ\text{C}$ )

Drain to Source Voltage	$V_{DSX}$	10	V
Gate1 to Source Voltage	$V_{G1S}$	-4.5	V
Gate2 to Source Voltage	$V_{G2S}$	-4.5	V
Drain Current	$I_D$	60	mA
Total Power Dissipation	$P_T$	200	mW
Channel Temperature	$T_{ch}$	125	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-55 to +125	$^\circ\text{C}$

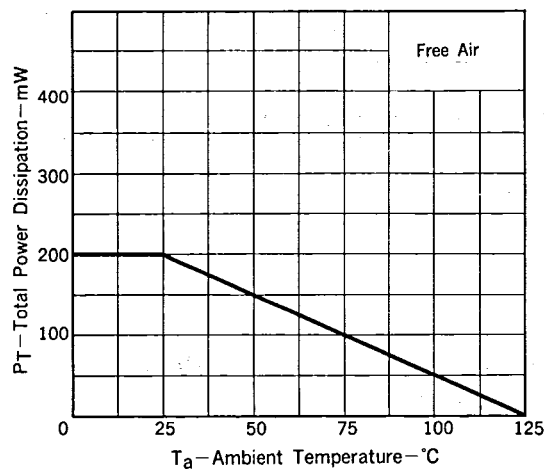
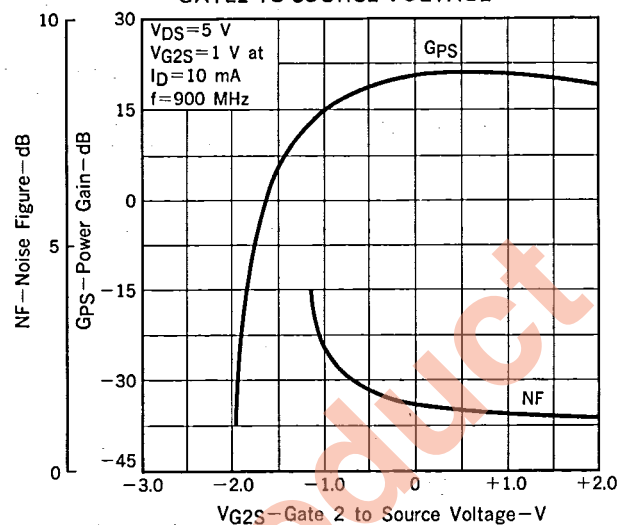
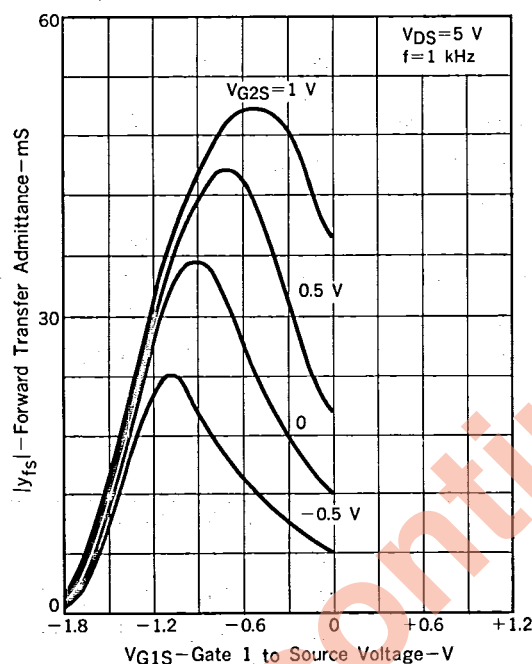
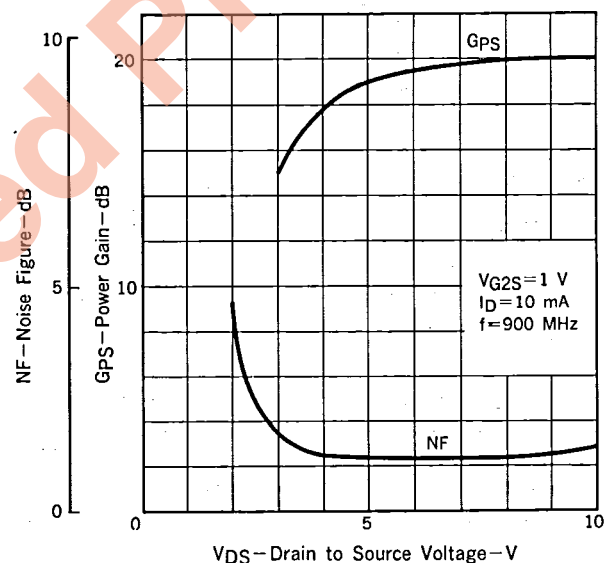
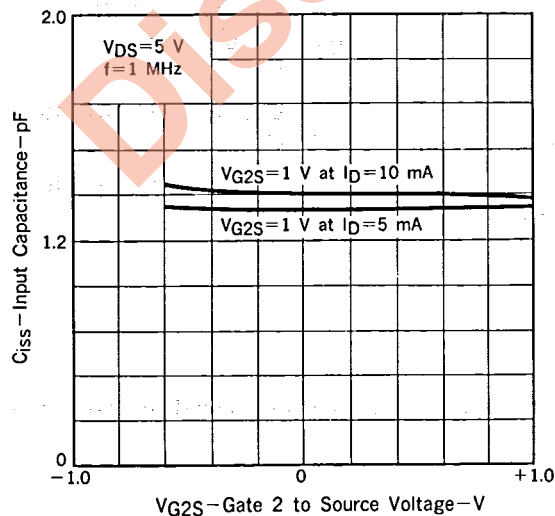
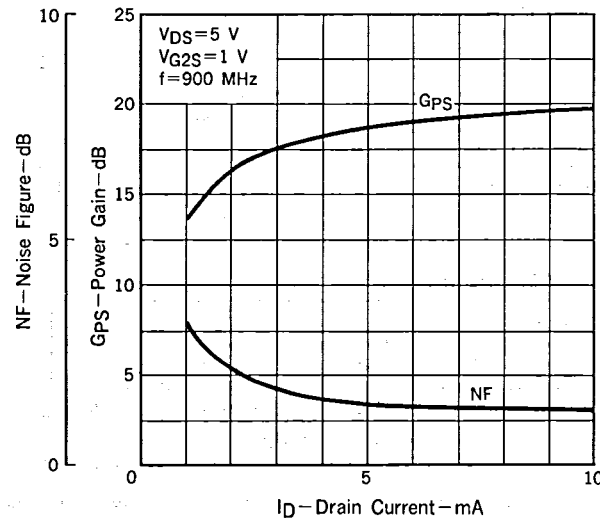
ELECTRICAL CHARACTERISTICS ( $T_a = 25^\circ\text{C}$ )

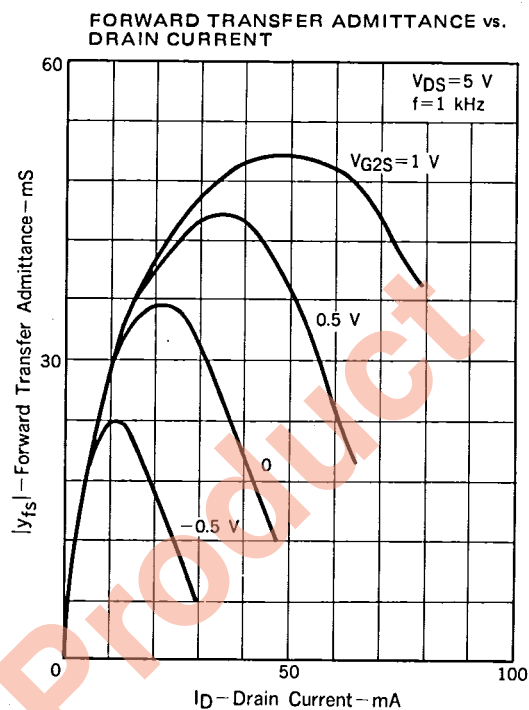
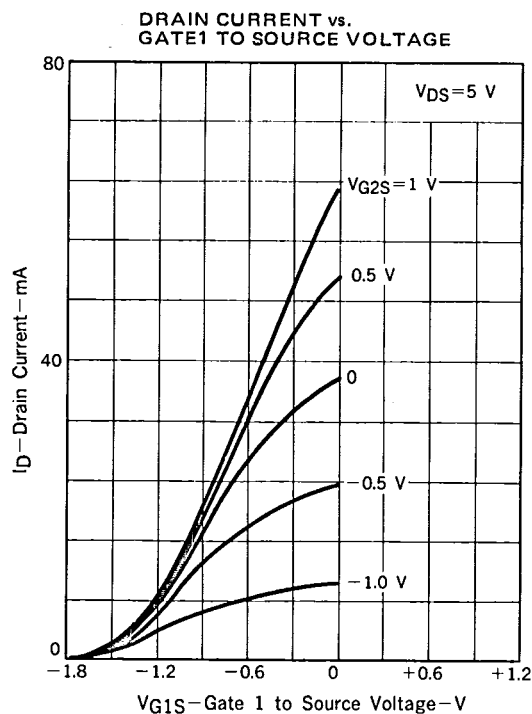
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source Breakdown Voltage	$BV_{DSX}$	10			V	$V_{G1S} = -4\text{ V}, V_{G2S} = 0, I_D = 20\text{ }\mu\text{A}$
Drain Current	$I_{DSS}$	8.0		60	mA	$V_{DS} = 5\text{ V}, V_{G1S} = 0, V_{G2S} = 0$
Gate1 to Source Cutoff Voltage	$V_{G1S(off)}$			-3.5	V	$V_{DS} = 5\text{ V}, V_{G2S} = 0, I_D = 100\text{ }\mu\text{A}$
Gate2 to Source Cutoff Voltage	$V_{G2S(off)}$			-3.5	V	$V_{DS} = 5\text{ V}, V_{G1S} = 0, I_D = 100\text{ }\mu\text{A}$
Gate1 Reverse Current	$I_{G1SS}$			10	$\mu\text{A}$	$V_{DS} = 0, V_{G1S} = -4\text{ V}, V_{G2S} = 0$
Gate2 Reverse Current	$I_{G2SS}$			10	$\mu\text{A}$	$V_{DS} = 0, V_{G2S} = -4\text{ V}, V_{G1S} = 0$
Forward Transfer Admittance	$ y_{fs} $	22	30		mS	$V_{DS} = 5\text{ V}, V_{G2S} = 1\text{ V}, I_D = 10\text{ mA}, f = 1.0\text{ kHz}$
Input Capacitance	$C_{iss}$	0.7	1.2	1.7	pF	$V_{DS} = 5\text{ V}, V_{G2S} = 1\text{ V}, I_D = 10\text{ mA}, f = 1.0\text{ MHz}$
Reverse Transfer Capacitance	$C_{rss}$		0.02	0.035	pF	
Power Gain	$G_{PS}$	16.0	20.0		dB	$V_{DS} = 5\text{ V}, V_{G2S} = 1\text{ V}, I_D = 10\text{ mA}, f = 900\text{ MHz}$
Noise Figure	NF		1.1	2.5	dB	

 $I_{DSS}$  Classification (Unit: mA)

Marking	N	M	L	K
$I_{DSS}$	8 to 25	20 to 35	30 to 50	45 to 60

**PRECAUTION:** Avoid high static voltages or electric fields so that this device would not suffer from any damage due to those voltage or fields.

TYPICAL CHARACTERISTICS ( $T_a = 25^\circ\text{C}$ )TOTAL POWER DISSIPATION vs.  
AMBIENT TEMPERATUREPOWER GAIN AND NOISE FIGURE vs.  
GATE2 TO SOURCE VOLTAGEFORWARD TRANSFER ADMITTANCE vs.  
GATE1 TO SOURCE VOLTAGEPOWER GAIN AND NOISE FIGURE vs.  
DRAIN TO SOURCE VOLTAGEINPUT CAPACITANCE vs.  
GATE2 TO SOURCE VOLTAGEPOWER GAIN AND NOISE FIGURE vs.  
DRAIN CURRENT



S-PARAMETER ( $V_{DS} = 5\text{ V}$ ,  $V_{G2S} = 1\text{ V}$ ,  $I_D = 10\text{ mA}$ )

FREQUENCY (MHz)	$S_{11}$		$S_{21}$		$S_{12}$		$S_{22}$	
	MAG	ANG	MAG	ANG	MAG	ANG	MAG	ANG
100.00	1.002	-2.6	2.671	176.4	0.006	111.8	0.942	-1.5
200.00	0.985	-7.2	2.714	166.2	0.003	105.3	0.932	-4.2
300.00	0.989	-8.8	2.628	161.4	0.004	92.2	0.941	-5.1
400.00	0.966	-13.2	2.578	155.0	0.006	104.0	0.938	-8.3
500.00	0.944	-14.3	2.567	154.0	0.006	85.9	0.930	-8.6
600.00	0.934	-19.7	2.712	144.4	0.008	71.5	0.948	-12.9
700.00	0.886	-19.9	2.557	138.0	0.006	94.8	0.923	-12.6
800.00	0.886	-24.9	2.598	131.8	0.010	86.3	0.943	-16.5
900.00	0.837	-26.0	2.525	128.1	0.007	86.9	0.921	-17.5
1000.00	0.840	-29.9	2.720	121.6	0.009	118.2	0.964	-21.4
1100.00	0.771	-30.4	2.560	113.3	0.004	120.0	0.926	-22.6
1200.00	0.788	-32.4	2.606	107.9	0.004	-178.7	0.992	-25.4

$$V_{DS} = 5 \text{ V}, V_{G2S} = 1 \text{ V}, I_D = 10 \text{ mA}$$
